2.7 VOLT 8K X 8 STATIC RAM

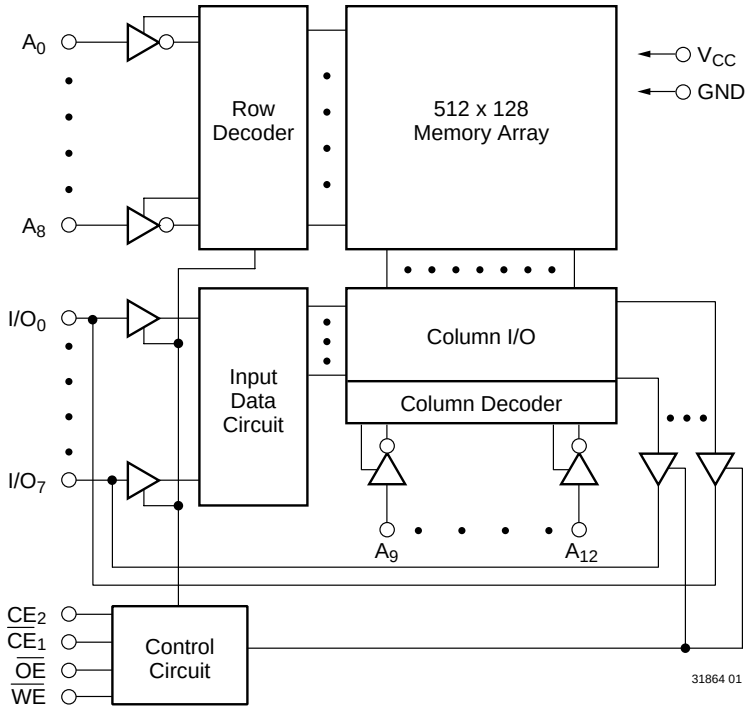
Features

- High-speed: 35, 70 ns
- Ultra low DC operating current of 2mA (Max.)
- Low Power Dissipation:
  - TTL Standby: 1 mA (Max.)
  - CMOS Standby: 10 μA (Max.)
- Fully static operation
- All inputs and outputs directly compatible
- Three state outputs
- Ultra low data retention current (V_{CC} = 2V)
- Extended operating voltage: 2.7V–3.6V
- Packages
  - 28-pin TSOP (Standard)
  - 28-pin 300 mil SOP (450 mil pin-to-pin)

Description

The V62C31864 is a 65,536-bit static random access memory organized as 8,192 words by 8 bits. It is built with MOSEL VITELIC's high performance CMOS process. Inputs and three-state outputs are TTL compatible and allow for direct interfacing with common system bus structures.

Functional Block Diagram



Device Usage Chart

Operating Temperature Range	Package Outline		Access Time (ns)		Power		Temperature Mark
	T	F	35	70	L	LL	
0°C to 70 °C	•	•	•	•	•	•	Blank
–40°C to +85°C	•	•	•			•	I

Pin Descriptions

A_0–A_{12} Address Inputs
These 13 address inputs select one of the 8,192 x 8 bit segments in the RAM.

$\overline{CE}_1$, CE_2 Chip Enable Inputs
$\overline{CE}_1$ is active LOW and CE_2 is active HIGH. Both chip enables must be active to read from or write to the device. If either chip enable is not active, the device is deselected and is in a standby power mode. The I/O pins will be in the high-impedance state when deselected.

$\overline{OE}$ Output Enable Input
The Output Enable input is active LOW. When $\overline{OE}$ is LOW with $\overline{CE}_1$ LOW, CE_2 HIGH, and $\overline{WE}$ HIGH, data of the selected memory location will be available on the I/O pins. When $\overline{OE}$ is HIGH, the I/O pins will be in the high impedance state.

$\overline{WE}$ Write Enable Input
An active LOW input, $\overline{WE}$ input controls read and write operations. When $\overline{CE}_1$ and $\overline{WE}$ inputs are both LOW with CE_2 HIGH, the data present on the I/O pins will be written into the selected memory location.

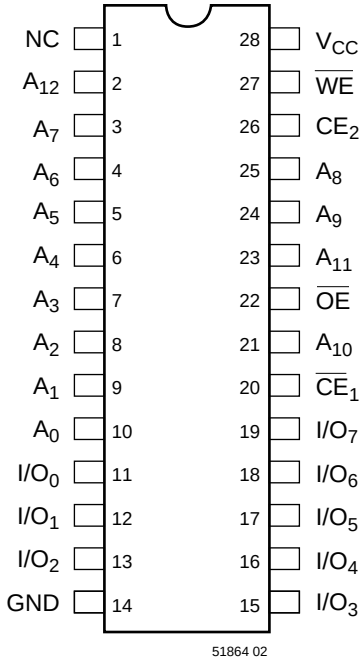
I/O_0–I/O_7 Data Input and Data Output Ports
These 8 bidirectional ports are used to read data from and write data into the RAM.

V_{CC} Power Supply

GND Ground

Pin Configurations (Top View)

28-Pin SOP



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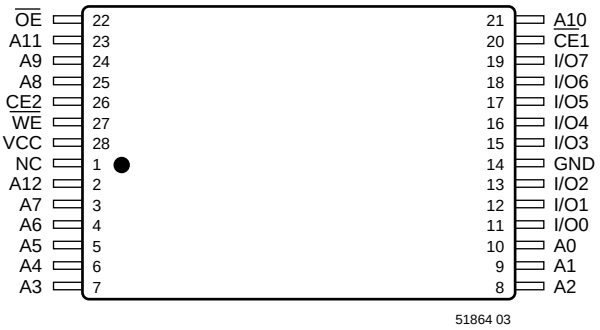
28-Pin TSOP (Standard)



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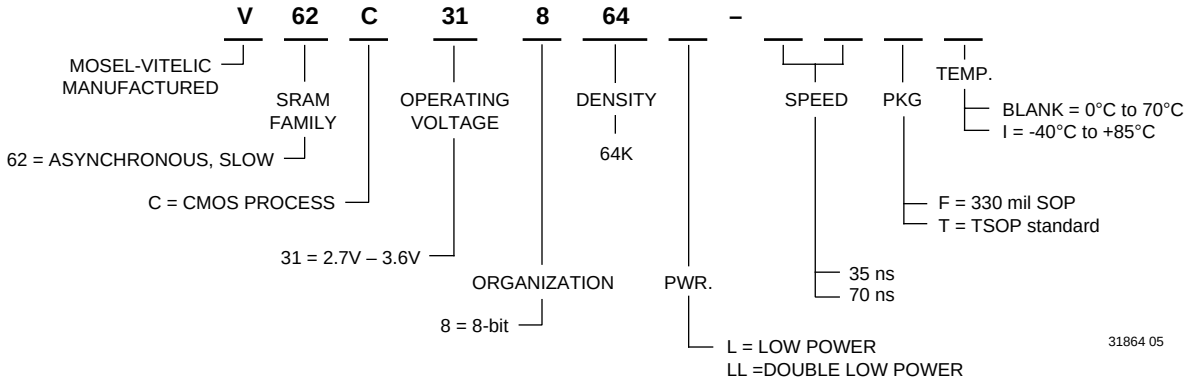
Part Number Information



Absolute Maximum Ratings (1)

Symbol	Parameter	Commercial	Industrial	Units
V_{CC}	Supply Voltage	-0.5 to V_{CC}+0.5	-0.5 to V_{CC}+0.5	V
V_N	Input Voltage	-0.5 to V_{CC}+0.5	-0.5 to V_{CC}+0.5	V
V_{DQ}	Input/Output Voltage Applied	V_{CC} + 0.3	V_{CC} + 0.3	V
T_{BIAS}	Temperature Under Bias	-10 to +125	-65 to +135	°C
T_{STG}	Storage Temperature	-55 to +125	-65 to +150	°C

NOTE:
1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Capacitance*

T_A = 25°C, f = 1.0MHz

Symbol	Parameter	Conditions	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	6	pF
C_{OUT}	Output Capacitance	$V_{I/O}$ = 0V	8	pF

NOTE:
* This parameter is guaranteed and not tested.

Truth Table

Mode	$\overline{CE}_1$	CE_2	$\overline{OE}$	$\overline{WE}$	I/O Operation
Standby	H	X	X	X	High Z
Standby	X	L	X	X	High Z
Output Disable	L	H	H	H	High Z
Read	L	H	L	H	D_{OUT}
Write	L	H	X	L	D_{IN}

NOTE:
X = Don't Care, L = LOW, H = HIGH

DC Electrical Characteristics (over all temperature ranges, V_{CC} = 2.7V – 3.6V)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{CC}	Power Supply Voltage		2.7	—	3.6	V
V_{IL}	Input LOW Voltage(1,2)		-0.3	—	0.4	V
V_{IH}	Input HIGH Voltage(1)		2.2	—	V_{CC}+0.3	V
I_{IL}	Input Leakage Current	V_{CC} = Max, V_{IN} = 0V to V_{CC}	-2	—	2	µA
I_{OL}	Output Leakage Current	V_{CC} = Max, $\overline{CE}$ = V_{IH}, V_{OUT} = 0V to V_{CC}	-2	—	2	µA
V_{OL}	Output LOW Voltage	V_{CC} = Min, I_{OL} = 2.1mA	—	—	0.4	V
V_{OH}	Output HIGH Voltage	V_{CC} = Min, I_{OH} = -1mA	2.4	—	—	V

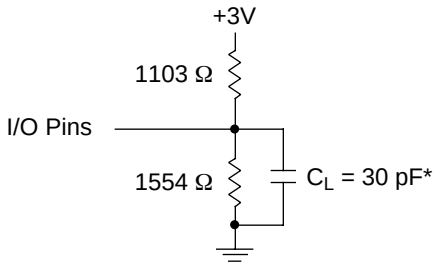
Symbol	Parameter		Com.(4)	Ind.(4)	Units
I_{CC}	Operating Power Supply Current, $\overline{CE}_1$ = V_{IL}, CE_2 = V_{IH}, Output Open, V_{CC} = Max., f = 0		2	2	mA
I_{CC1}	Average Operating Current, $\overline{CE}_1$ = V_{IL}, CE_2 = V_{IH}, Output Open, V_{CC} = Max., f = f_{MAX}(3)		40	40	mA
I_{SB}	TTL Standby Current $\overline{CE}_1$ ≥ V_{IH}, CE_2 ≤ V_{IL}, V_{CC} = Max.	L	2	3	mA
		LL	1	1	
I_{SB1}	CMOS Standby Current, $\overline{CE}_1$ ≥ V_{CC} – 0.2V, CE_2 ≤ 0.2V, V_{IN} ≥ V_{CC} – 0.2V or V_{IN} ≤ 0.2V, V_{CC} = Max.	L	40	50	µA
		LL	10	15	

NOTES:
1. These are absolute values with respect to device ground and all overshoots due to system or tester noise are included.
2. V_{IL} (Min.) = -3.0V for pulse width < 20ns.
3. $f_{MAX} = 1/t_{RC}$.
4. Maximum values.

AC Test Conditions

Input Pulse Levels	0 to 3V
Input Rise and Fall Times	5 ns
Timing Reference Levels	1.5V
Output Load	see below

AC Test Loads and Waveforms



* Includes scope and jig capacitance

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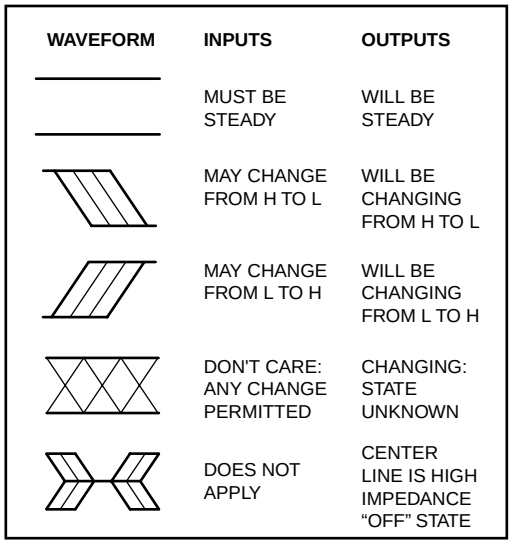
Key to Switching Waveforms

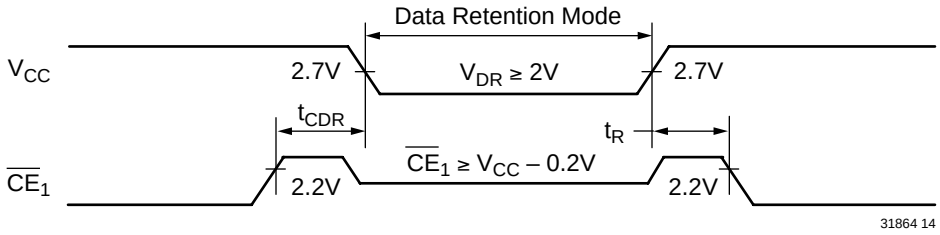


Data Retention Characteristics

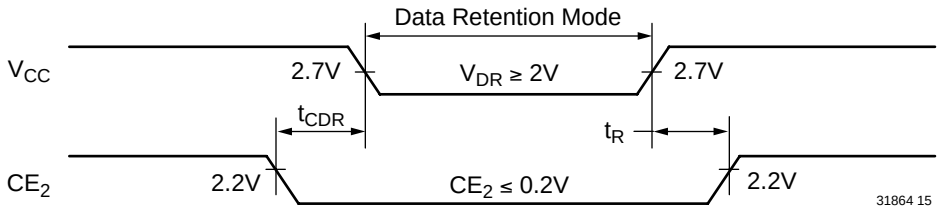
Symbol	Parameter			Min.	Typ.(2)	Max.	Units
V_{DR}	V_{CC} for Data Retention $\overline{CE}_1 \geq V_{CC} - 0.2V$, $CE_2 \leq 0.2V$, $V_{IN} \geq V_{CC} - 0.2V$, or $V_{IN} \leq 0.2V$			2.0	—	3.6	V
I_{CCDR}	Data Retention Current $CE_1 \geq V_{DR} - 0.2V$, $CE_2 \leq 0.2V$, $V_{IN} \geq V_{CC} - 0.2V$, or $V_{IN} \leq 0.2V$	Com'l	L	—	0.5	40	µA
			LL	—	0.5	10	
		Ind.	L	—	—	45	
			LL	—	—	15	
t_{CDR}	Chip Deselect to Data Retention Time			0	—	—	ns
t_R	Operation Recovery Time (see Retention Waveform)			t_{RC}(1)	—	—	ns

NOTES:
1. t_{RC} = Read Cycle Time
2. T_A = +25°C.

Low V_{CC} Data Retention Waveform (1) ($\overline{CE}_1$ Controlled)



Low V_{CC} Data Retention Waveform (2) (CE_2 Controlled)



AC Electrical Characteristics

(over all temperature ranges, V_{CC} = 2.7V – 3.6V)

Read Cycle

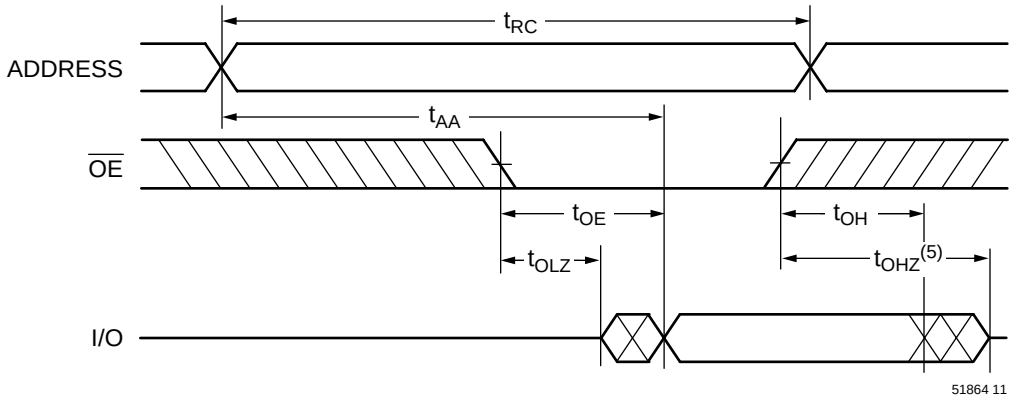
Parameter Name	Parameter	-35		-70		Unit
		Min.	Max.	Min.	Max.	
t_{RC}	Read Cycle Time	35	—	70	—	ns
t_{AA}	Address Access Time	—	35	—	70	ns
t_{ACS1}	Chip Enable Access Time	—	35	—	70	ns
t_{ACS2}	Chip Enable Access Time	—	35	—	70	ns
t_{OE}	Output Enable to Output Valid	—	15	—	30	ns
t_{CLZ1}	Chip Enable to Output in Low Z	5	—	5	—	ns
t_{CLZ2}	Chip Enable to Output in Low Z	5	—	5	—	ns
t_{OLZ}	Output Enable to Output in Low Z	5	—	5	—	ns
t_{CHZ}	Chip Disable to Output in High Z	0	20	0	20	ns
t_{OHZ}	Output Disable to Output in High Z	0	20	0	20	ns
t_{OH}	Output Hold from Address Change	5	—	5	—	ns

Write Cycle

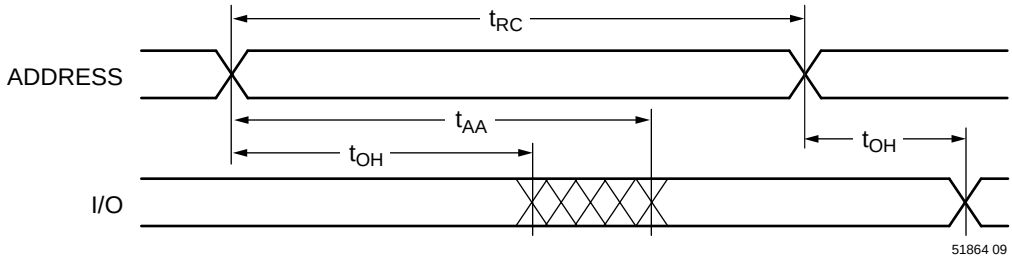
Parameter Name	Parameter	-35		-70		Unit
		Min.	Max.	Min.	Max.	
t_{WC}	Write Cycle Time	35	—	70	—	ns
t_{CW1}	Chip Enable to End of Write	35	—	70	—	ns
t_{CW2}	Chip Enable to End of Write	35	—	70	—	ns
t_{AS}	Address Setup Time	0	—	0	—	ns
t_{AW}	Address Valid to End of Write	35	—	70	—	ns
t_{WP}	Write Pulse Width	25	—	50	—	ns
t_{WR}	Write Recovery Time	0	—	0	—	ns
t_{WHZ}	Write to Output High-Z	0	20	0	25	ns
t_{DW}	Data Setup to End of Write	25	—	30	—	ns
t_{DH}	Data Hold from End of Write	0	—	0	—	ns
t_{OW}	Output Active from End of Write	5	—	5	—	ns

Switching Waveforms (Read Cycle)

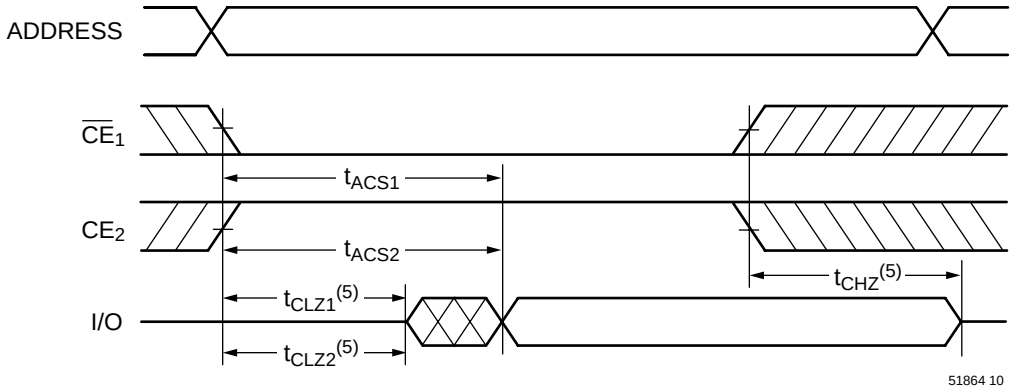
Read Cycle 1(1, 2)



Read Cycle 2(1, 2, 4)



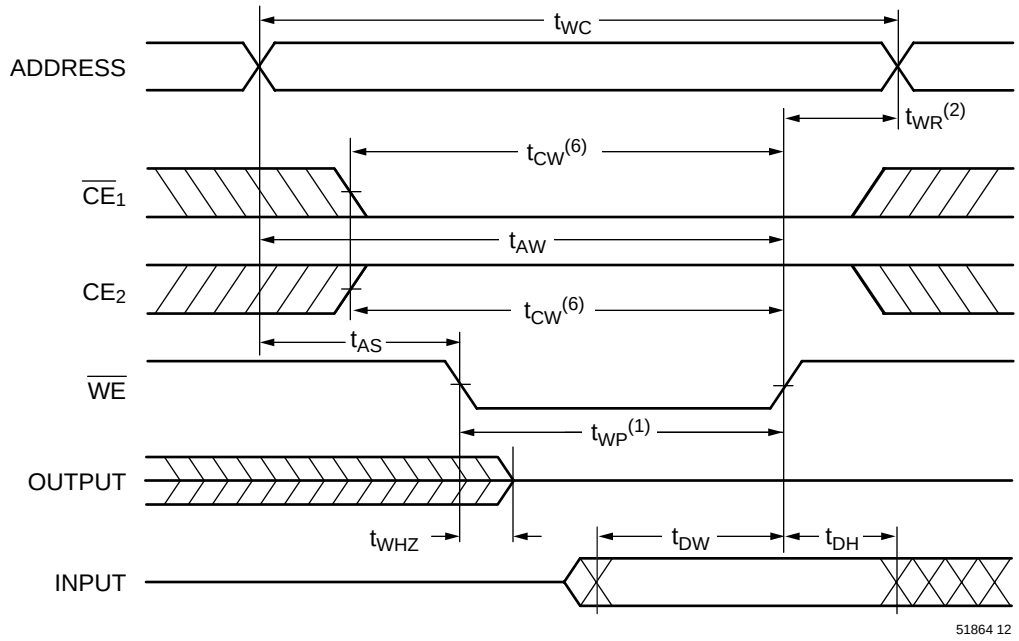
Read Cycle 3(1, 3, 4)



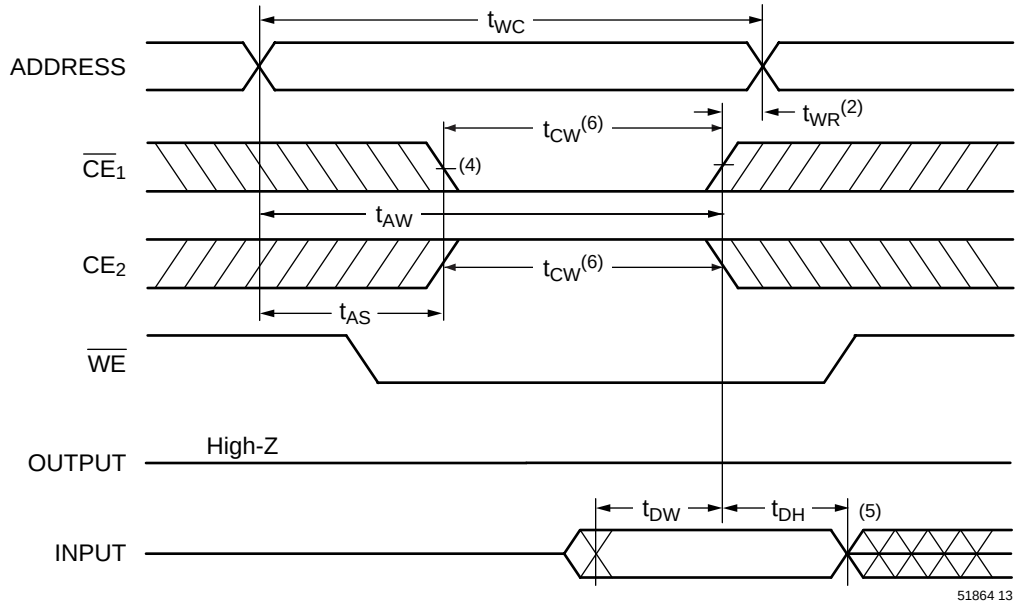
NOTES:
1. $\overline{WE}$ = V_{IH}.
2. $\overline{CE}_1$ = V_{IL} and CE_2 = V_{IH}.
3. Address valid prior to or coincident with $\overline{CE}_1$ transition LOW and/or CE_2 transition HIGH.
4. $\overline{OE}$ = V_{IL}.
5. Transition is measured ±500mV from steady state with C_L = 5pF. This parameter is guaranteed and not 100% tested.

Switching Waveforms (Write Cycle)

Write Cycle 1 ($\overline{WE}$ Controlled)(4)



Write Cycle 2 ($\overline{CE}$ Controlled)(4)



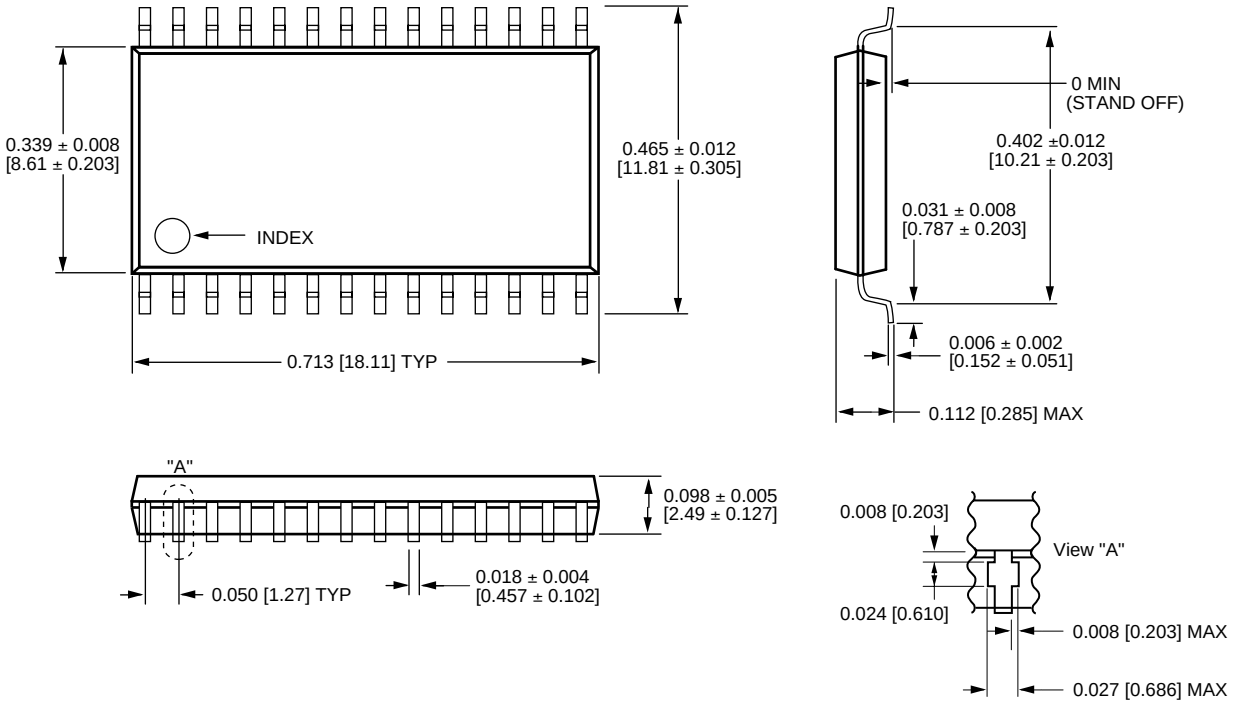
NOTES:

1. The internal write time of the memory is defined by the overlap of $\overline{CE}_1$ and CE_2 active and $\overline{WE}$ low. Both signals must be active to initiate and any one signal can terminate a write by going inactive. The data input setup and hold timing should be referenced to the second transition edge of the signal that terminates the write.
2. t_{WR} is measured from the earlier of $\overline{CE}_1$ or $\overline{WE}$ going HIGH, or CE_2 going LOW at the end of the write cycle.
3. During this period, I/O pins are in the output state so that the input signals of opposite phase to the outputs must not be applied.
4. $\overline{OE}$ = V_{IL} or V_{IH}. However it is recommended to keep $\overline{OE}$ at V_{IH} during write cycle to avoid bus contention.
5. If $\overline{CE}_1$ is LOW and CE_2 is HIGH during this period, I/O pins are in the output state. Then the data input signals of opposite phase to the outputs must not be applied to them.
6. t_{CW} is measured from $\overline{CE}_1$ going LOW or CE_2 going HIGH to the end of write.

Package Diagrams

28-pin 330 mil SOP

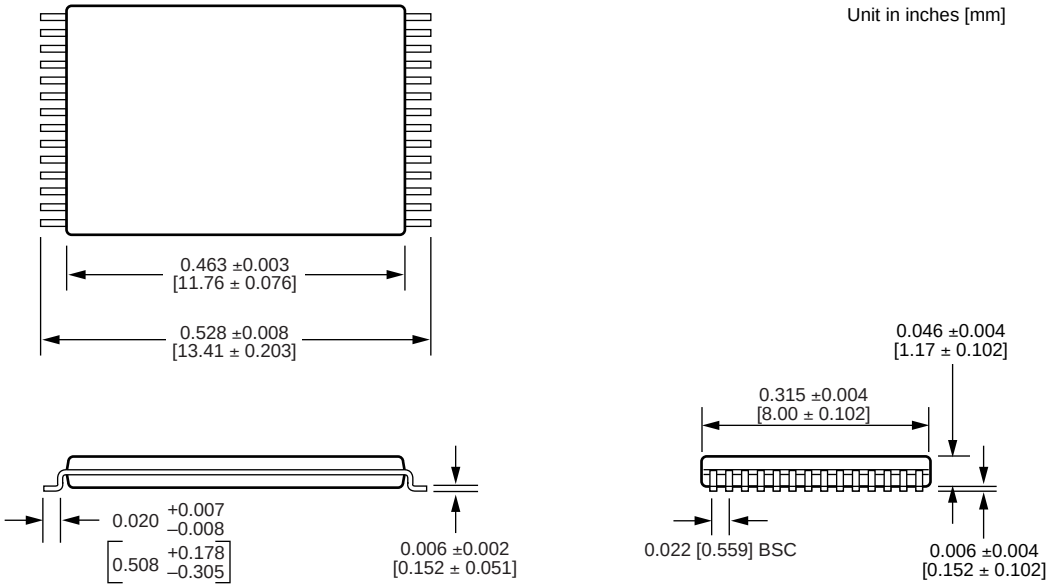
Units in inches [mm]



Package Diagrams (Cont'd)

28-Pin TSOP

Unit in inches [mm]



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